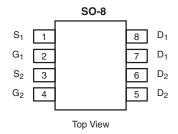


Vishay Siliconix

Dual N-Channel 25 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^{a, e}	Q _g (Typ.)			
	0.018 at V _{GS} = 10 V	8				
25	0.020 at V _{GS} = 4.5 V	8	7.8 nC			
	0.024 at V _{GS} = 2.5 V	7.5				



FEATURES

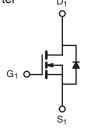
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

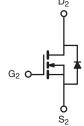


ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Synchronous Buck Converter
- DC/DC Converter





N-Channel MOSFET

N-Channel MOSFET

Ordering Information: Si4228DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATIN	IGS T _A = 25 °C,	unless othe	erwise noted	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	25	V	
Gate-Source Voltage		V_{GS}	± 12	v
	T _C = 25 °C		8 ^e	
Continuous Drain Current /T 150 °C)	T _C = 70 °C	1 .	8 ^e	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	8 ^{b, c, e}	
	T _A = 70 °C		6.9 ^{b, c}	A
Pulsed Drain Current		I _{DM}	50	^
Continuous Source Drain Diade Current	T _C = 25 °C	I _S	2.6	
Continuous Source-Drain Diode Current	T _A = 25 °C		1.7 ^{b, c}	
Single Pulse Avalanche Current Avalanche Energy L = 0.1 mH		I _{AS}	15	
		E _{AS}	11.25	mJ
	T _C = 25 °C	- P _D	3.1	
Maximum Power Dissipation	T _C = 70 °C		2	w
Maximum Power Dissipation	T _A = 25 °C		2 ^{b, c}	VV
	T _A = 70 °C		1.3 ^{b, c}	
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	52	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	30	40	- C/VV		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 110 $^{\circ}\text{C/W}.$
- e. Package limited.

Si4228DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				·	L		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 vA		20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 3.2			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	0.6		1.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zava Cata Valtaga Drain Current	I _{DSS}	V _{DS} = 25 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current		V _{DS} = 25 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
		$V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$		0.015	0.018		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.016	0.020	Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.020	0.024		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 7 A		68		S	
Dynamic ^b							
Input Capacitance	C _{iss}			790		pF	
Output Capacitance	C _{oss}	$V_{DS} = 12.5 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		146			
Reverse Transfer Capacitance	C _{rss}			76			
Total Cata Obayasa	$Q_g \qquad V_{DS} = 12.5$	$V_{DS} = 12.5 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8.6 \text{ A}$		16.5	25		
Total Gate Charge				7.8	12	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 12.5 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 8.6 \text{ A}$		1.6			
Gate-Drain Charge	Q_{gd}			1.7			
Gate Resistance	R_g	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time	t _{d(on)}			7	14		
Rise Time	t _r	V_{DD} = 12.5 V, R_{L} = 1.8 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6.9 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		21	30		
Fall Time	t _f			10	20	ns	
Turn-On Delay Time	t _{d(on)}			4	8		
Rise Time	t _r	$V_{DD} = 12.5 \text{ V}, R_{L} = 1.8 \Omega$		9	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6.9 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t _f			7	14		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.6	Α	
Pulse Diode Forward Current ^a	I _{SM}				50		
Body Diode Voltage	V_{SD}	I _S = 6.9 A		0.82	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	23	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 6.9 A, dI/dt = 100 A/μs, T _{.I} = 25 °C		6	12	nC	
Reverse Recovery Fall Time	t _a	i _F = 0.3 A, αι/αι = 100 A/μs, 1 _J = 25 °C		8			
everse Recovery Rise Time t _b				7		ns	

Notes

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

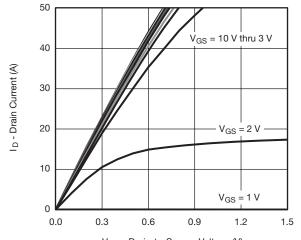
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing.



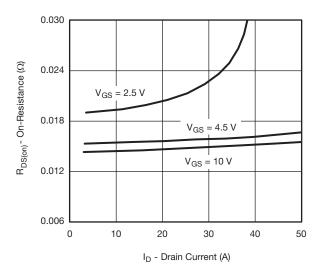
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

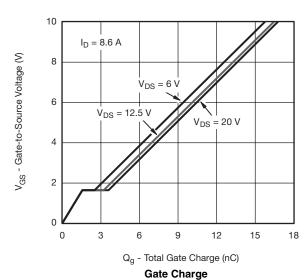


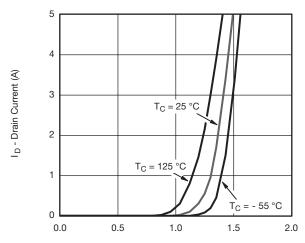
 $V_{\mbox{\scriptsize DS}}$ - Drain-to-Source Voltage (V)

Output Characteristics



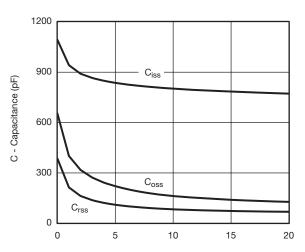
On-Resistance vs. Drain Current and Gate Voltage





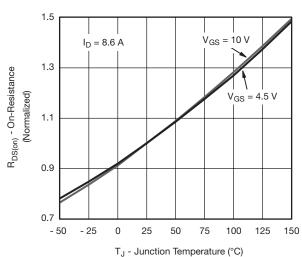
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



V_{DS} - Drain-to-Source Voltage (V)

Capacitance



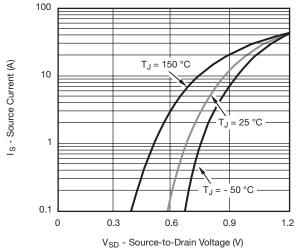
On-Resistance vs. Junction Temperature

Si4228DY

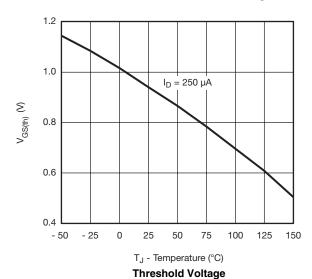
Vishay Siliconix

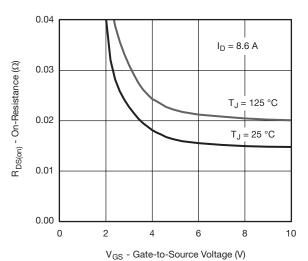
VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

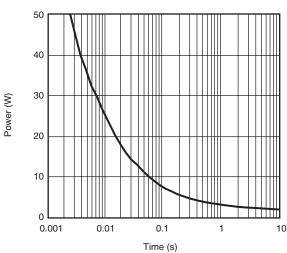


Source-Drain Diode Forward Voltage

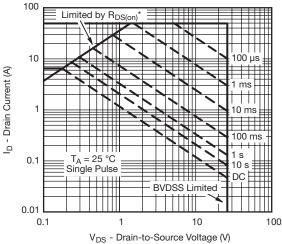




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



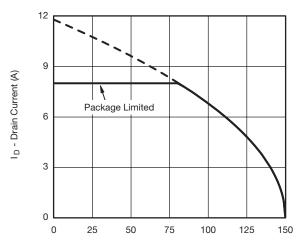
*V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient



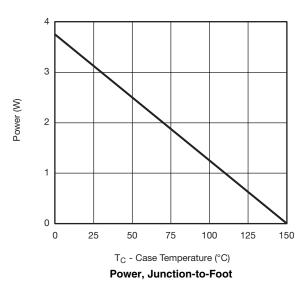
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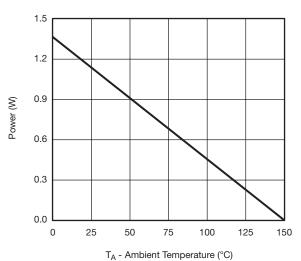
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





Power, Junction-to-Ambient

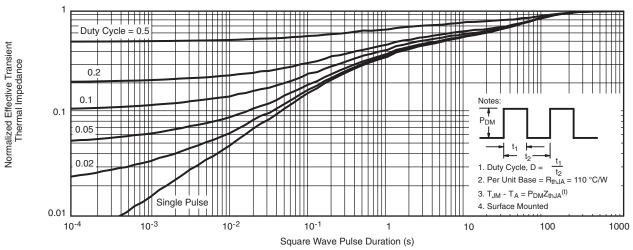
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4228DY

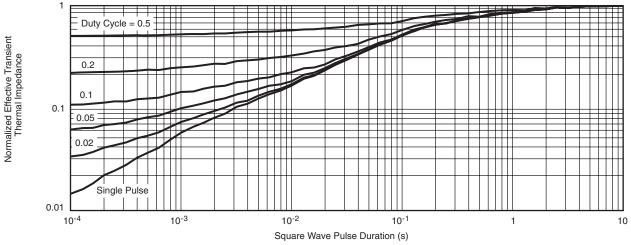
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?66591.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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